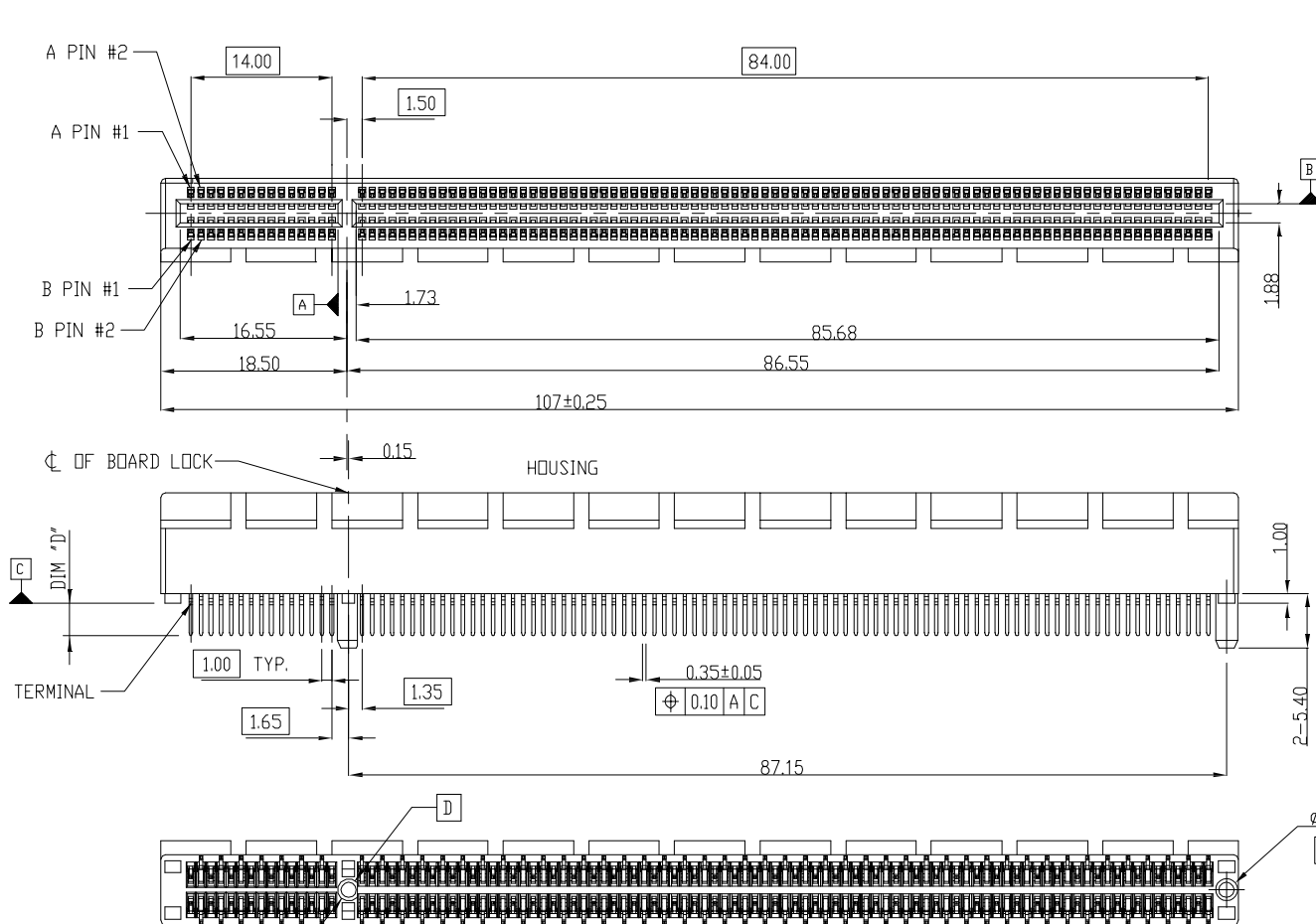
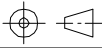
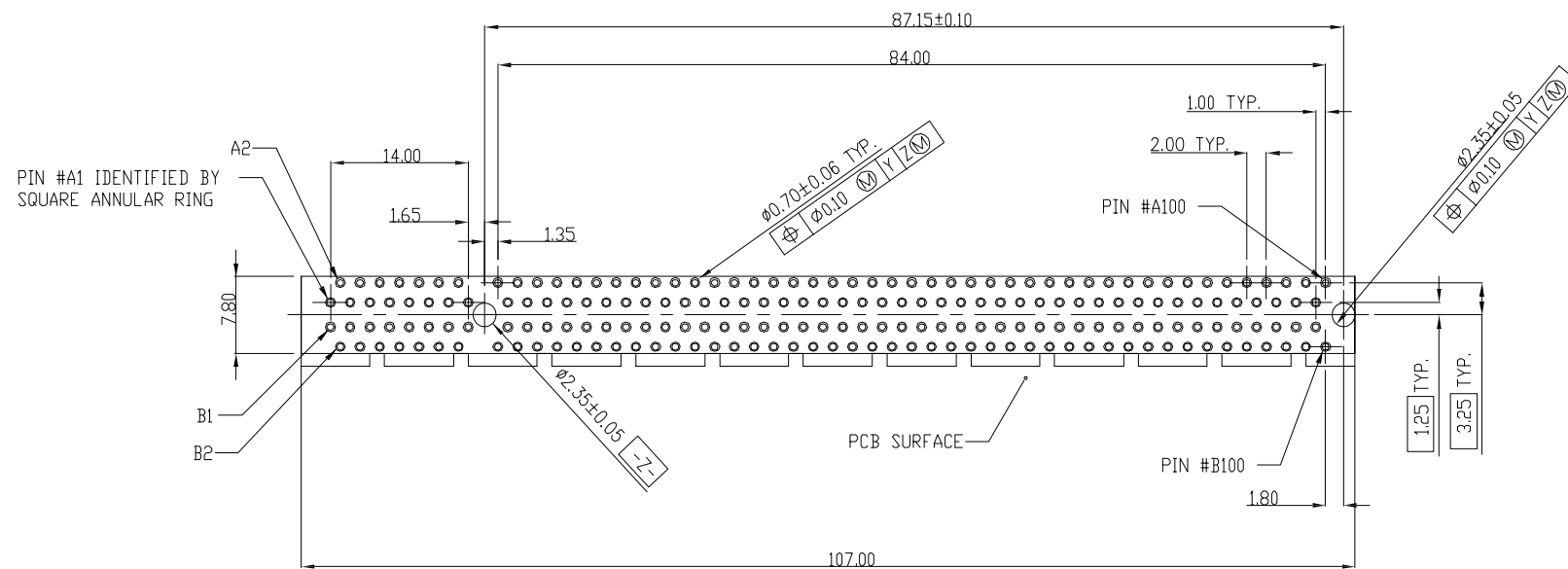


PROD NO
SEE NOTE



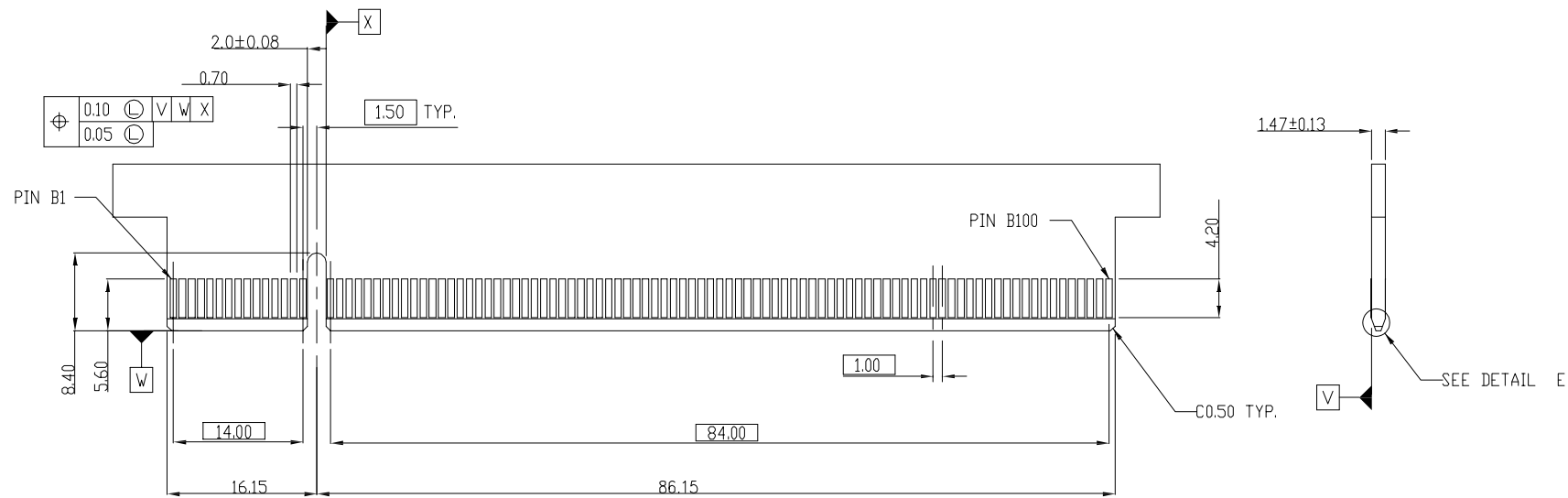
mat'l. code				tolerances unless otherwise specified				CUSTOMER COPY		A FCI www.fciconnect.com				
ltr	ecn no		dr	date	linear	.X ±.38				projection 	title PCI-E 200P CARD EDGE GEN3 			
A	T06-0079		J.H	4/14/06		.XX ±.25								
B	ELX-DG-21161-1		S T	05/27/15		.XXX ±.10								
					angles	0° ±2°								
					dr	STONE LI	05/27/15		product family			PCI		code
					engr	STONE LI	05/27/15		size			dwg no		—
					chr	/	/		scale			A4		sheet
					appd	PM ZHENG	05/27/15	N/A	10054652			1 of 4		
sheet index	revision sheet		B 1	B 2	B 3	B 4								



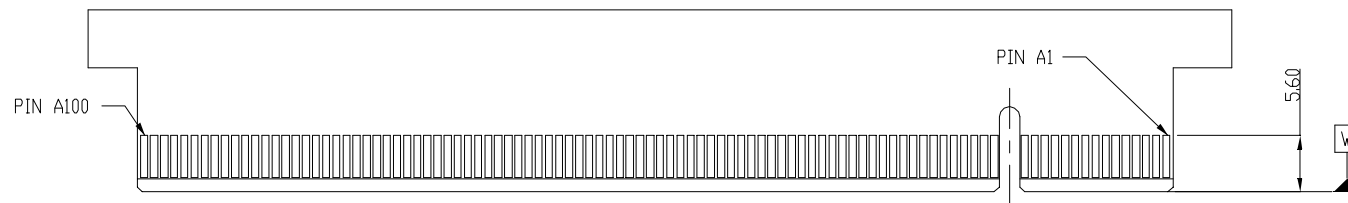
MOTHER BOARD FOOTPRINT PATTERN
CONECTOR SIDE SHOWN

mat'l. code				tolerances unless otherwise specified				CUSTOMER COPY				A FCI www.fciconnect.com									
ltr	ecn no	dr	date	linear	.X ±.38				projection	title											
					.XX ±.25					PCI-E 200P CARD EDGE GEN3											
					.XXX ±.10																
				angles	0° ±2°																
				dr	STONE LI	05/27/15		MM		product family				PCI				code			
				enr	STONE LI	05/27/15				size				dwg no				—			
				chr	/	/			scale	A4				10054652				sheet			
				appd	PM ZHENG	05/27/15		N/A								2 of 4					
sheet index		revision sheet																			

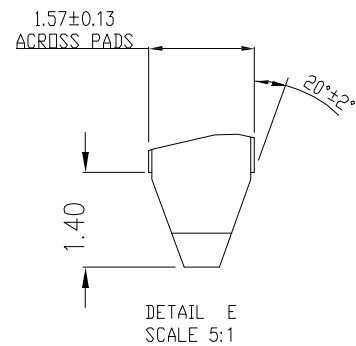
cage code
22526

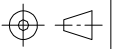


← I/O PANEL DIRECTION
PRIMARY (COMPONENT) SIDE



→ I/O PANEL DIRECTION
SECONDARY (SOLDER) SIDE



mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY	 www.fciconnect.com		
ltr	ecn no	dr	date	linear	.X ±.38	.XX ±.25				
					.XXX ±.10	0° ±2°	projection	 MM		
				angles						
				dr	STONE LI	05/27/15	scale	product family PCI size dwg no A4 10054652		
				enrg	STONE LI	05/27/15				
				chr	/	/	N/A	code - sheet 3 of 4		
				appd	PM ZHENG	05/27/15				
sheet index	revision sheet									

cage code
22526

NOTES:

1.MATERIAL:

HOUSING: THERMOPLASTIC WITH GLASS FIBER, UL94V-0,
COLOR IN BLACK.
CONTACTS: COPPER ALLOY.

2.FINISH:

CONTACTS: GOLD PLATING ON CONTACT AREA,
100 μ MIN. TIN/LEAD OR MATTE TIN (LEAD FREE OPTION) PLATING ON SOLDER TAILS,
50 μ MIN. NICKEL UNDERPLATING OVER ALL.
BOARDLOCKS: 100 μ TIN/LEAD OR MATTE TIN (LEAD FREE OPTION) PLATING ON SOLDER TAILS,
50 μ MIN. NICKEL UNDERPLATING OVER ALL.

3. DURABILITY: 50 CYCLES.

4. RoHS COMPATIBLE PRODUCT SPECIFICATIONS

- a. PLATING: "LF" MEANS THE PRODUCT IS LEAD FREE, 2.5um min. MATTE PURE TIN OVER 1.27um MIN. NICKEL UNDERPLATE.
- b. MANUFACTURING PROCESS COMPATIBILITY: THE HOUSING WILL WITHSTAND EXPOSURE TO 260C $\pm$ 5C $\pm$ SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60MM THICK CIRCUIT BOARD.

PRODUCT NUMBER CODE

10054652 - X X X X X X LF

HOUSING COLOR OPTIONS
1-BLACK

PEGS OPTIONS
0-PLASTIC PEGS

TERMINAL PLATING OPTIONS
0-50 μ Ni UNDERPLATE
30 μ Au CONTACT AREA
100 μ TIN TAIL AREA -----COMPATIBLE RoHS
1-50 μ Ni UNDERPLATE
15 μ Au CONTACT AREA
100 μ TIN TAIL AREA -----COMPATIBLE RoHS
2-50 μ Ni UNDERPLATE
GOLD FLASH CONTACT AREA
100 μ TIN TAIL AREA -----COMPATIBLE RoHS

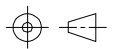
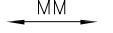
LEAD FREE

PACKAGING OPTIONS
T-TRAY PACKAGING

RESERVE
0

TAIL LENGTH OPTIONS

	DIM "D"	SUGGESTED PCB THICKNESS
1	3.10	2.36 $\pm$ 0.10
2	2.54	1.56 $\pm$ 0.10

mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY	 www.fciconnect.com	
ltr	ecn no	dr	date	linear	.X $\pm$.38 .XX $\pm$.25 .XXX $\pm$.10			
				angles	0' $\pm$ 2'			
		dr		STONE LI	05/27/15	projection 	title PCI-E 200P CARD EDGE GEN3 	
		enrg		STONE LI	05/27/15	MM 		
		chr		/	/	scale N/A	product family PCI size dwg no A4 10054652	
		appd		PM ZHENG	05/27/15		sheet 4 of 4	
sheet index	revision sheet						cage code 22526	